

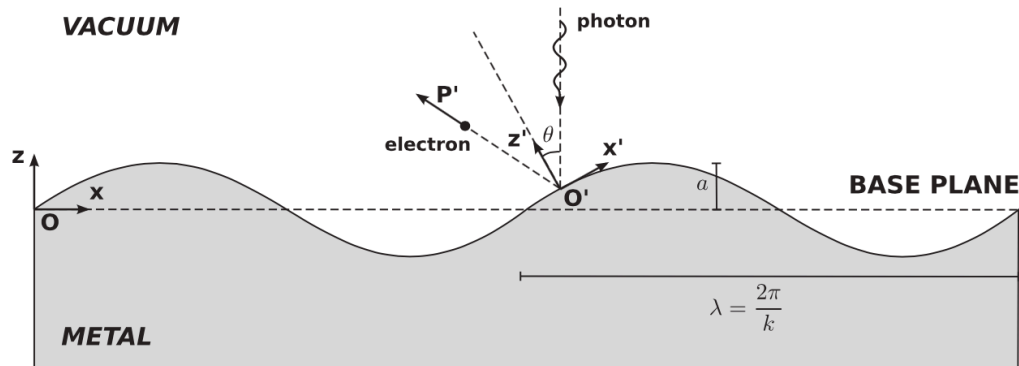
Surface analysis and n-machining of the copper photocathode at SPARC_LAB

Jessica Scifo
On behalf of SPARC_LAB collaboration

- Motivation
- Background
- Surface Analysis Techniques
 - Scanning Electron Microscopy with Energy Dispersive Spectroscopy
 - Atomic Force Microscopy
- Machining and Results
- Conclusions

Motivation

- **High brightness** (high current, **low emittance**) **electron beam** production by photoinjector at SPARC_LAB
- **Surface roughness** on cathode introduces a transverse electric field that increases the transverse momentum, causing **emittance growth**



a , amplitude of the uneven surface
 λ , period of fluctuation

$$\varepsilon_{ns} = \sigma_x \sqrt{\frac{e\pi^2 a_n^2 E_{rf} \sin \vartheta_{rf}}{2m_0 c^2 \lambda_n}}$$

Z. Zhang and C. Tang, *Analytical study on emittance growth caused by roughness of a metallic photocathode*,
 PRST-AB 18, 053401 (2015)

D. Xiang et al., *First principle measurements of thermal emittance for copper and magnesium*, Proc. of PAC07, Albuquerque, New Mexico, USA

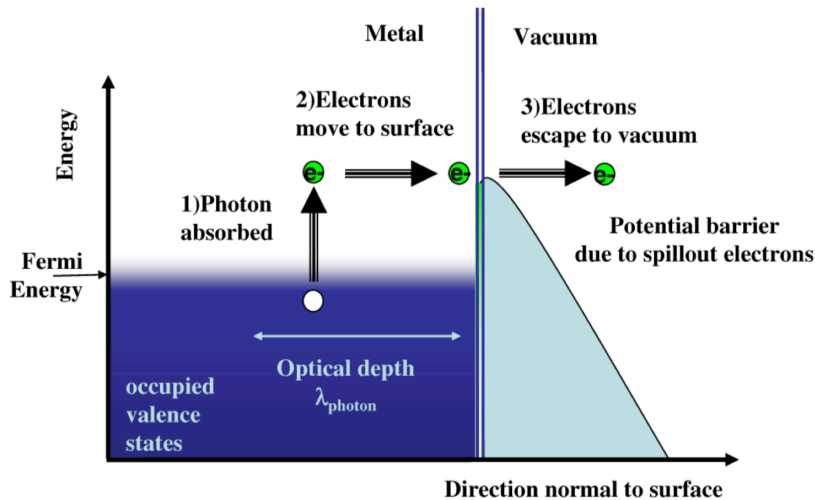
- A **R&D activity** on photocathodes is under development at the SPARC_LAB test facility in order to fully know and characterize each stage of the photocathode “life”
- The **n-machining** is useful to reduce roughness and to avoid surface contamination caused by other procedures, for example the polishing with diamond paste or the machining with oil

➤ ELECTRON EMISSION PROCESS OF METALLIC PHOTOCATHODES AND THE 3-STEP MODEL

Photoelectric emission from a metal given by Spicer's 3-step model:

1. Photon absorption by the electron
2. Electron transport to the surface
3. Escape through the barrier

QE and emittance depend upon electronic structure of the cathode



The *Quantum Efficiency (QE)* is:

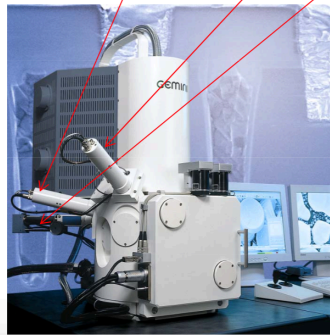
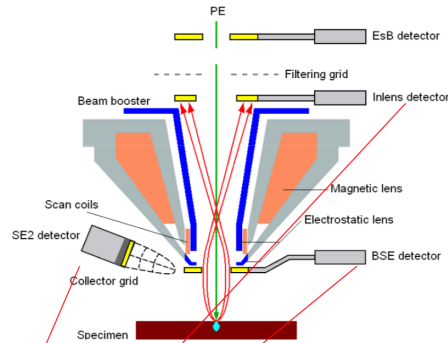
$$QE = \frac{n_e}{n_p} = \frac{h\nu [eV]}{E_{laser} [J]} q [C]$$

The *thermal emittance (ϵ_{th})* is:

$$\epsilon_{th} = \sigma_x \sigma_{p_x} = \sigma_x \sqrt{\frac{\hbar\omega - \phi_{eff}}{3mc^2}}$$

The electric potential energy is:

$$e\phi_{eff} = e\phi_{work} - \frac{e^2}{16\pi\epsilon_0 x} - eE_0 x$$



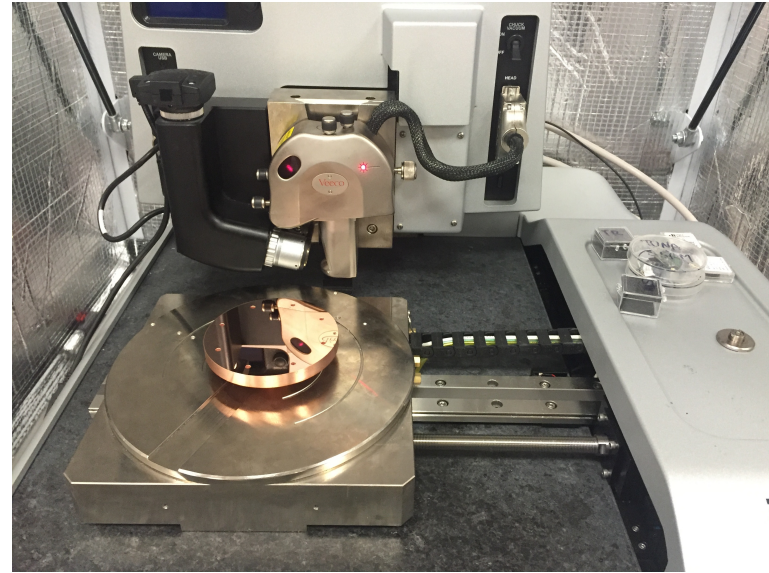
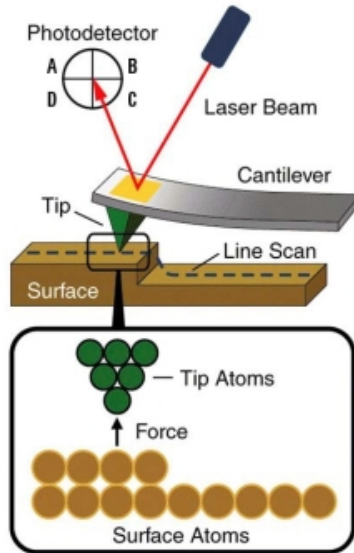
The types of signals produced by a SEM include:

- secondary electrons (**SE**), emitted from very close to the sample surface (**morphology**);
- back scattered electrons (**BSE**): electrons beam that are reflected from the sample by elastic scattering (**atomic number, Z**).

Technical features	
Emitter	Tungsten filament
High vacuum resolution (SE)	3.0 nm at 30 kV
Low, medium vacuum resolution (BSE)	3.5 nm at 30 kV
Magnification	Continuous from 4x to 10 ⁶ x
Acceleration voltage	200 V to 30 kV
Beam current	1 pA to 2 μ A

➤ We are able to determine the chemical composition of the test sample with the Energy Dispersive Spectroscopy (EDS).

AFM (Atomic Force Microscopy)



The surface roughness is represented by two different values :

$$\left\{ \begin{array}{l} R_a = (1/L) \int_0^L |Z(x)| dx \\ RMS(R_q) = \left[(1/L) \int_0^L Z(x)^2 dx \right]^{1/2} \end{array} \right.$$

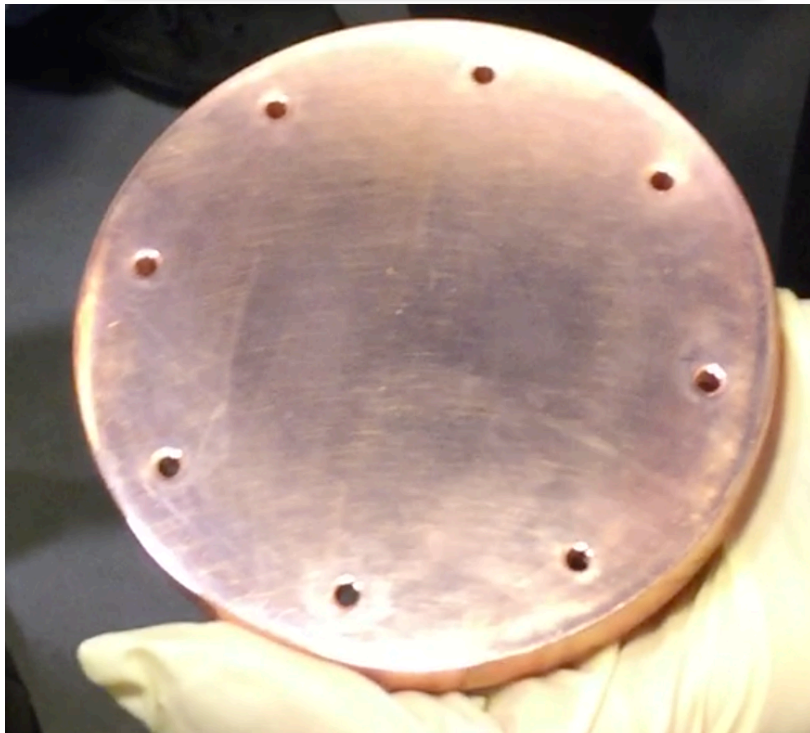
Where: L= evaluation length;
Z(x) = the profile height function.

The Machining

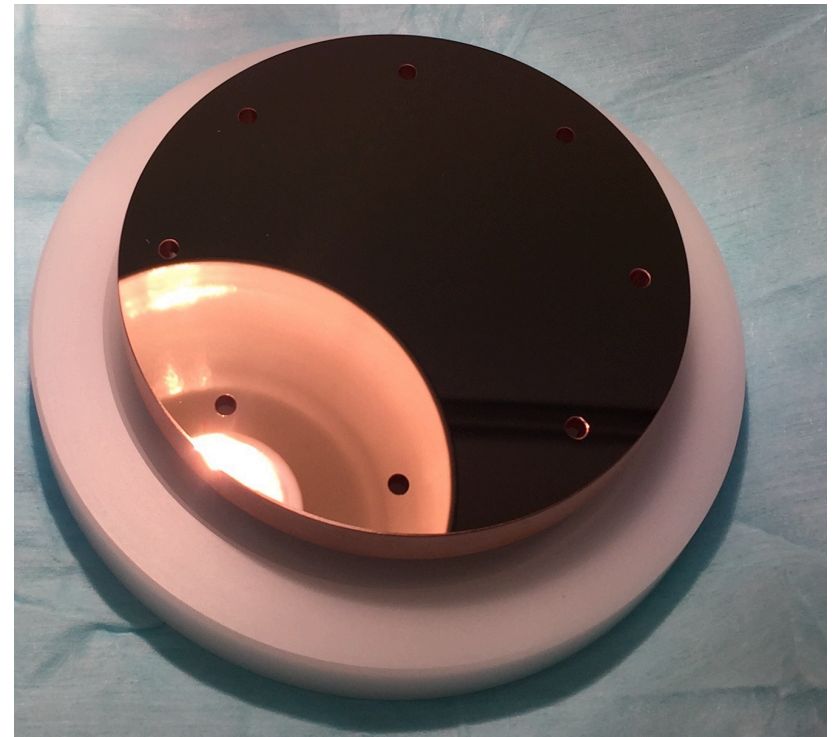
➤ The cathode surface has been machined by means of diamond milling and blown with nitrogen. The machining has been done without the use of any oil or cooling fluid (dry machining).

BEFORE MACHINING

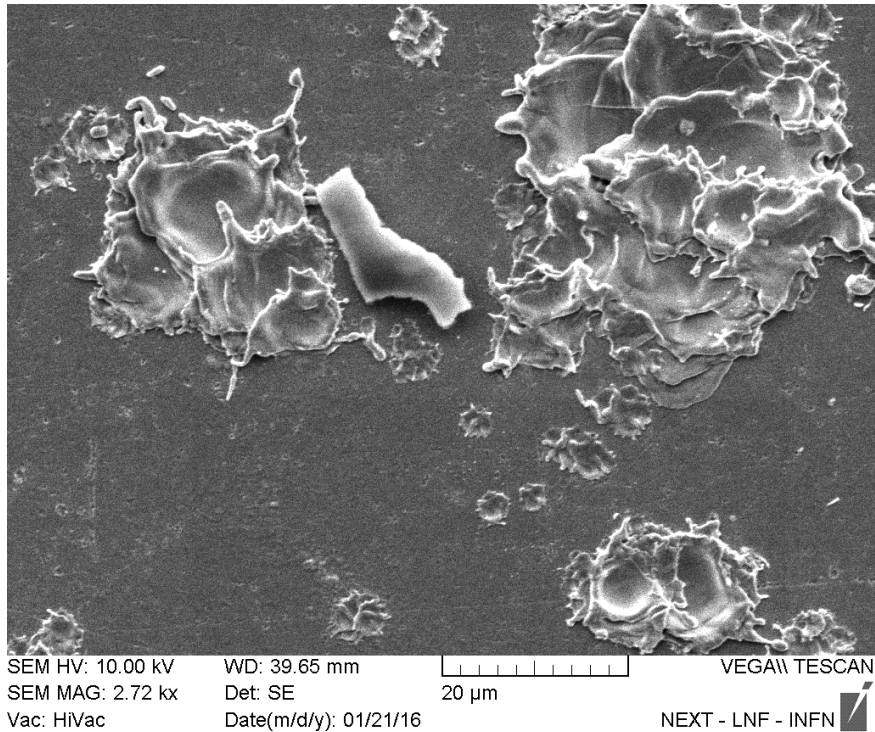
Our cathode time life was about 6 years



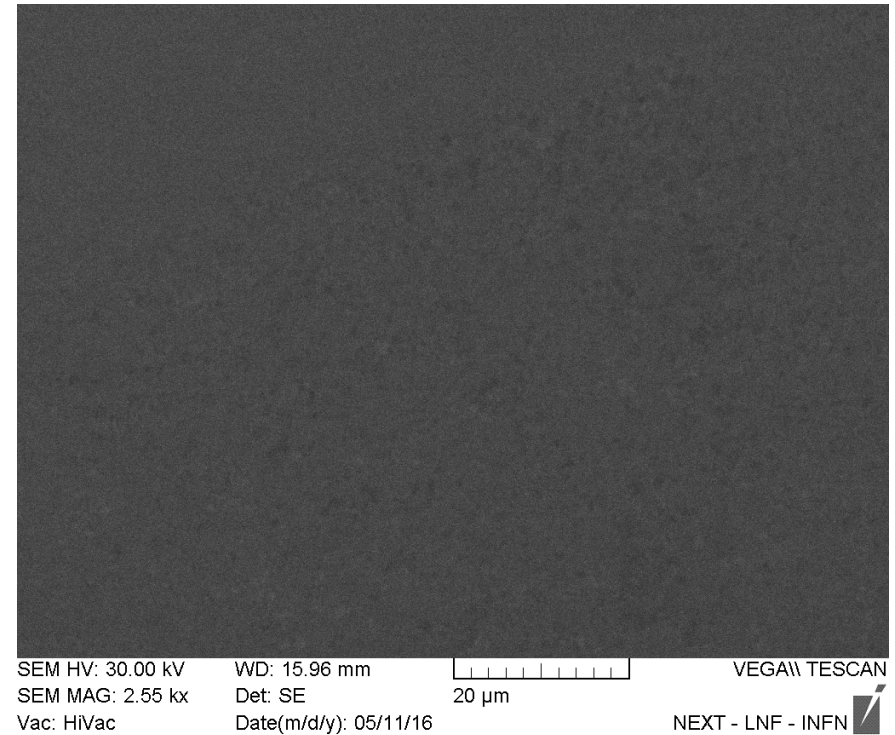
AFTER MACHINING



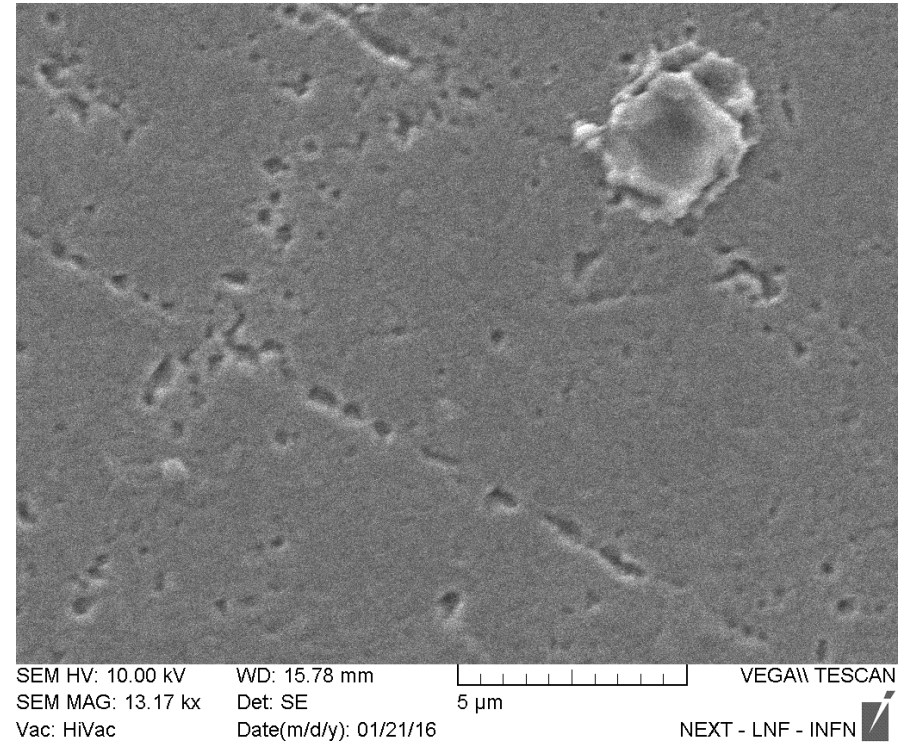
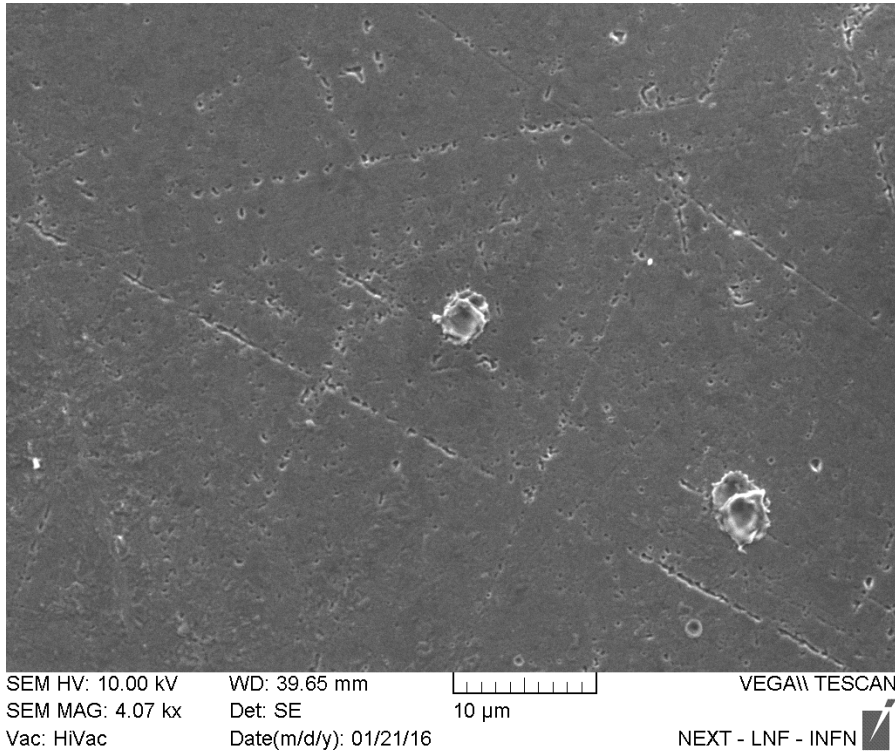
BEFORE MACHINING

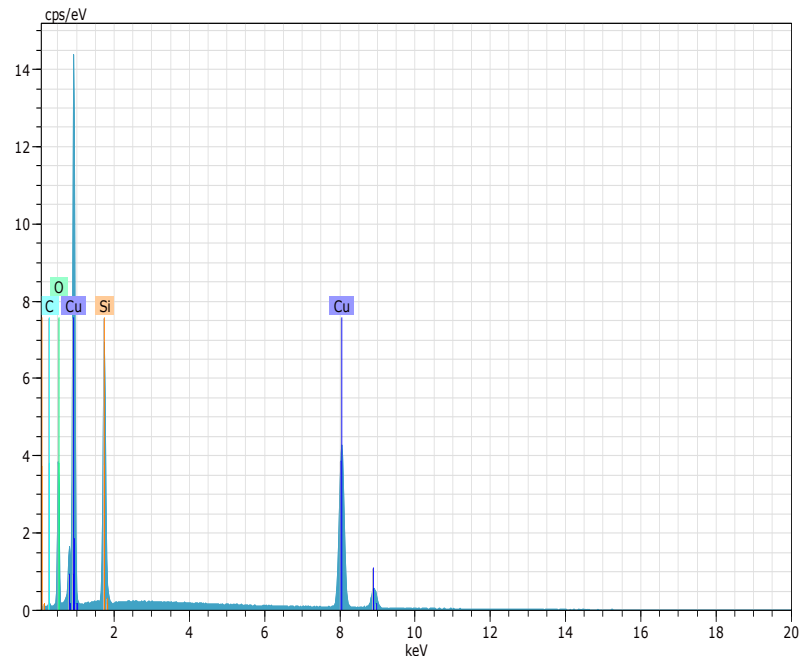
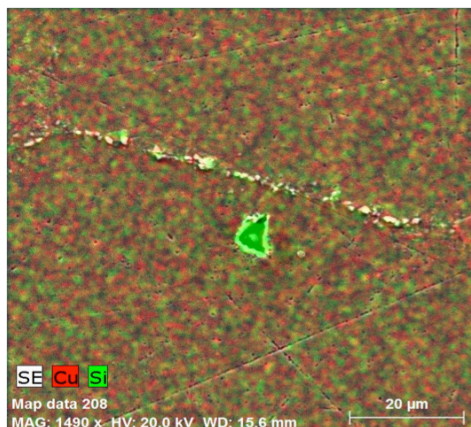
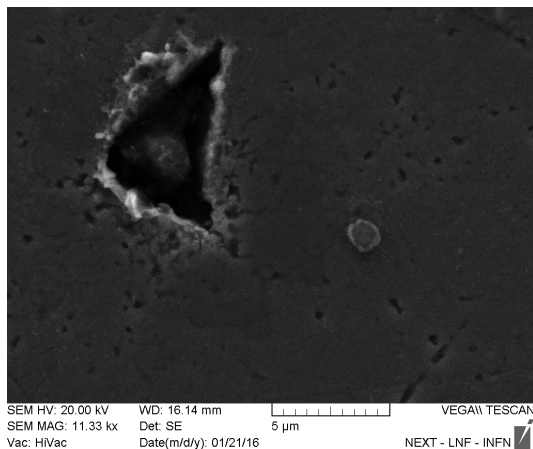


AFTER MACHINING



Measurements before machining



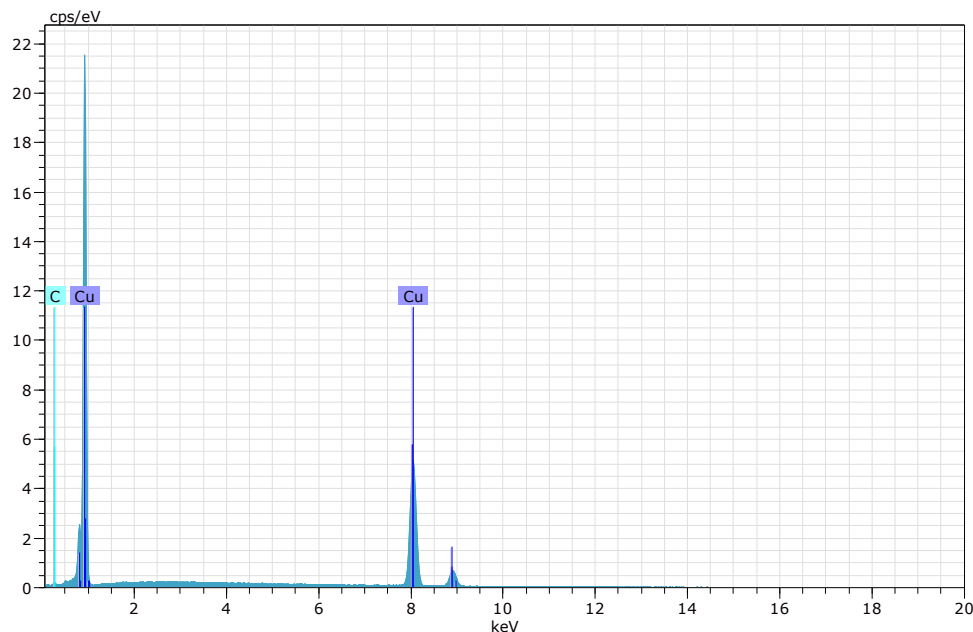
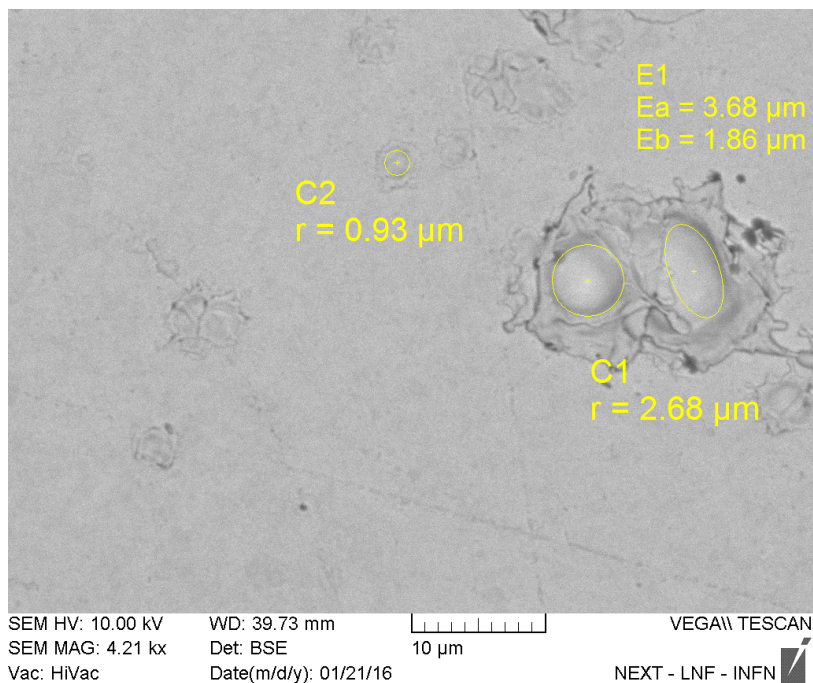


Spectrum: Acquisition 862 - particella.spx

El	AN	Series	unn.	C norm.	C Atom.	C Error (1 Sigma)	K fact.	Z corr.	A corr.	F corr.
			[wt.%]	[wt.%]	[at.%]					

Cu	29	K-series	62.20	63.79	34.62	1.72	0.548	1.114	1.000	1.044
O	8	K-series	17.08	17.51	37.76	2.31	0.377	0.464	1.000	1.000
Si	14	K-series	15.46	15.86	19.47	0.69	0.131	1.203	1.000	1.004
C	6	K-series	2.77	2.84	8.15	0.76	0.077	0.369	1.000	1.000

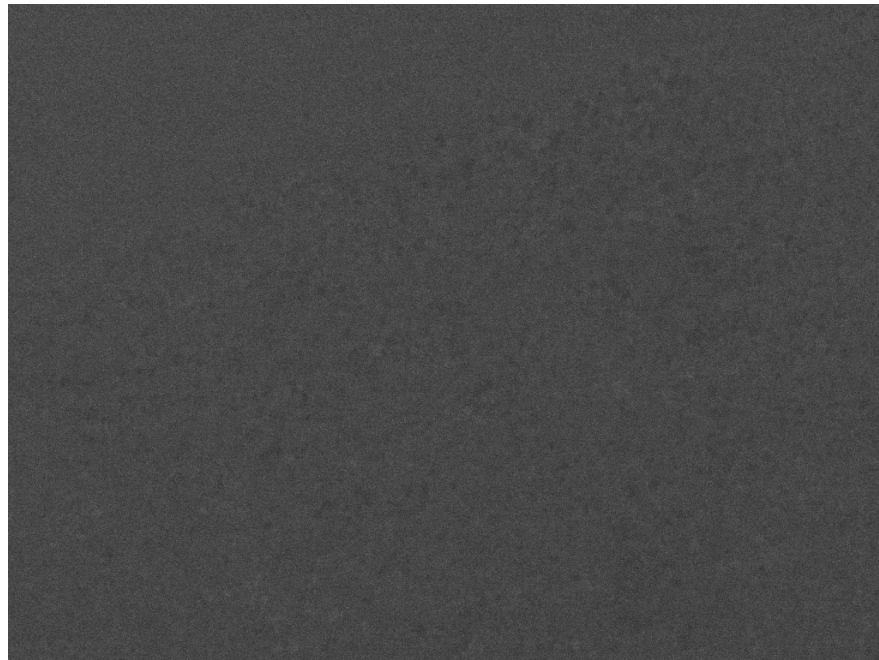
Total: 97.51 100.00 100.00



Spectrum: Acquisition 861-Generale.spx

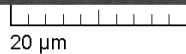
El	AN	Series	unn. [wt.%]	C norm. [wt.%]	C Atom. [at.%]	Error (1 Sigma)	K fact.	Z corr.	A corr.	F corr.
Cu	29	K-series	88.20	96.47	83.80	2.42	0.862	1.078	1.000	1.039
C	6	K-series	3.22	3.53	16.20	0.86	0.091	0.387	1.000	1.000
Total:			91.43	100.00	100.00					

Measurements after machining



SEM HV: 30.00 kV
SEM MAG: 2.55 kx
Vac: HiVac

WD: 15.96 mm
Det: SE
Date(m/d/y): 05/11/16

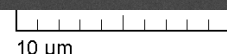


VEGA\\ TESCAN
NEXT - LNF - INFN



SEM HV: 30.00 kV
SEM MAG: 6.14 kx
Vac: HiVac

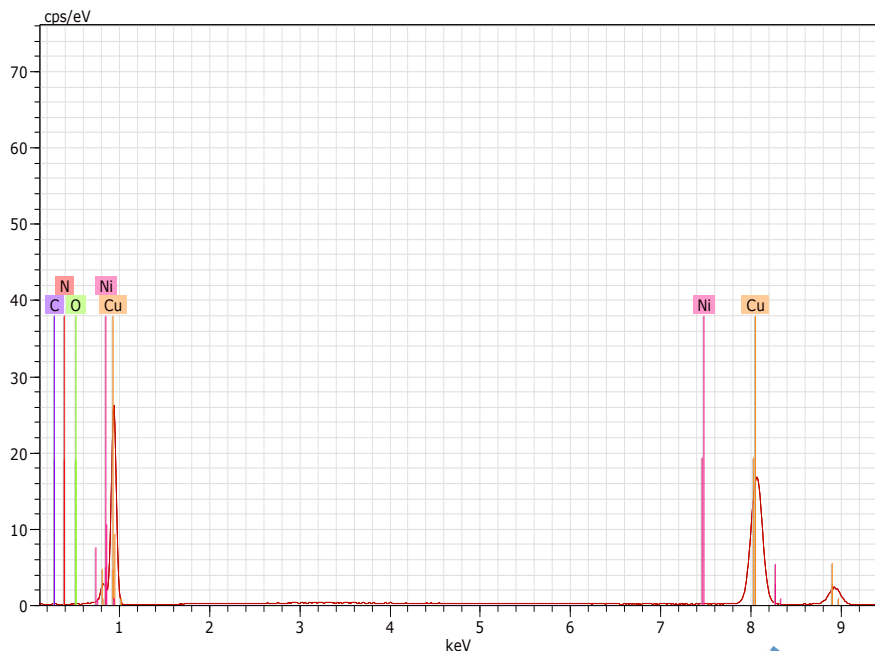
WD: 15.91 mm
Det: SE
Date(m/d/y): 05/11/16



VEGA\\ TESCAN
NEXT - LNF - INFN

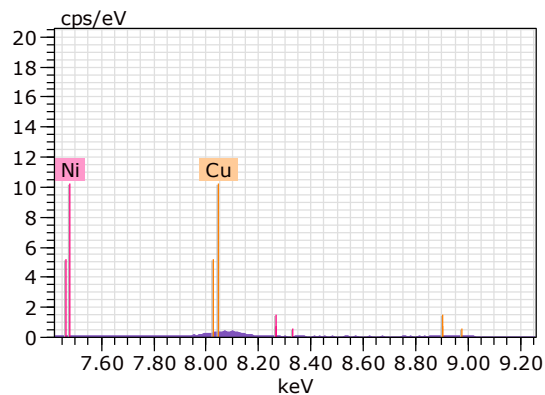
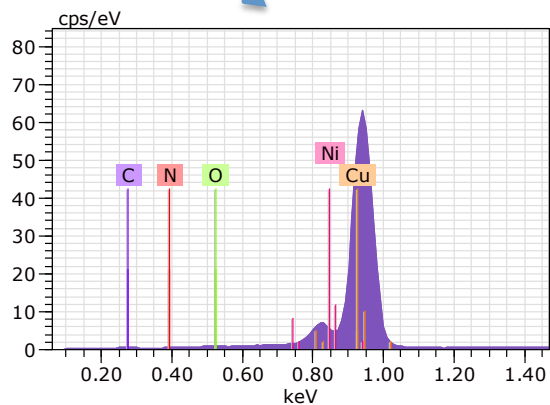


Chemical composition

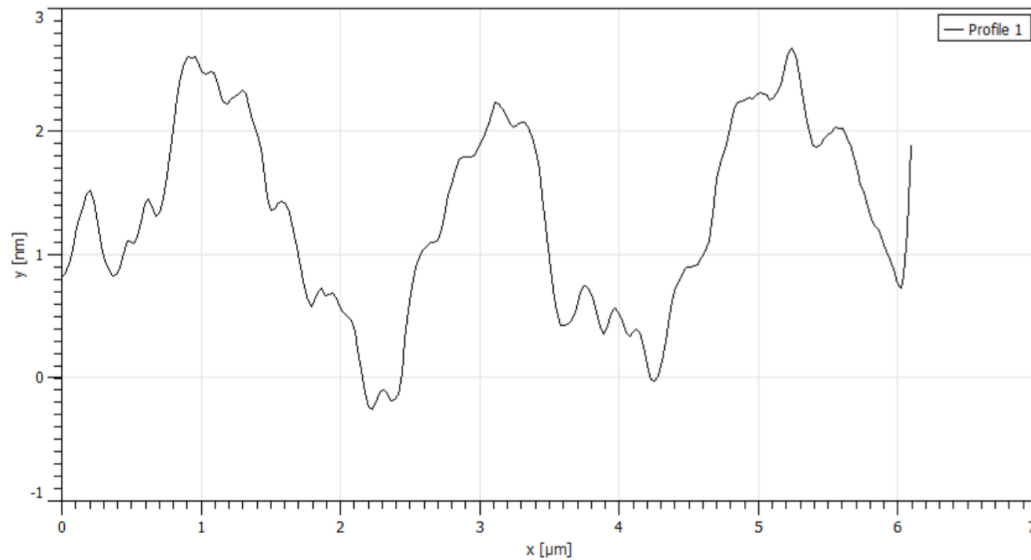
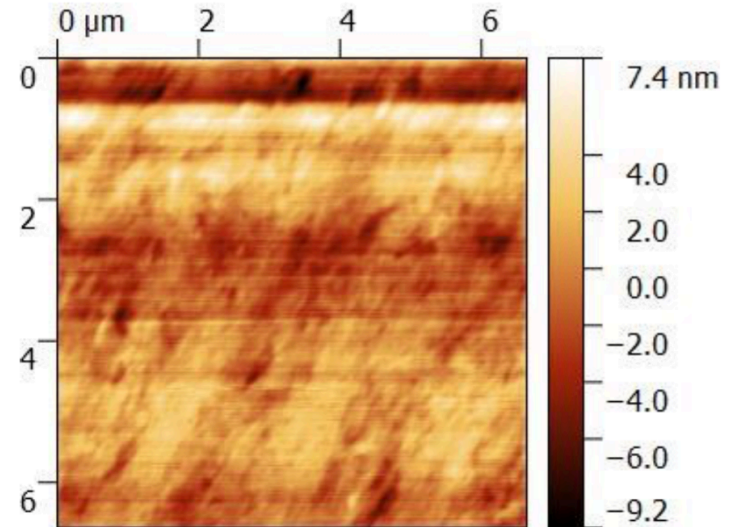
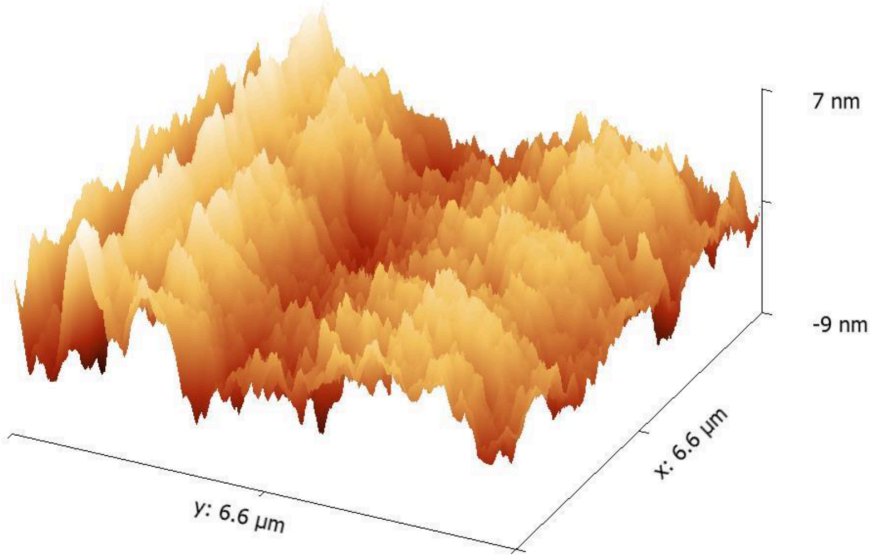


Spectrum: Acquisition 877

El	AN	Series	Net unkn.	C norm.	C Atom.	C Error (1 Sigma)
			[wt.%]	[wt.%]	[at.%]	[wt.%]
Cu	29	L-series	289089	98.81	98.81	95.69
C	6	K-series	1280	0.47	0.47	2.39
Ni	28	L-series	1453	0.34	0.34	0.35
O	8	K-series	1150	0.22	0.22	0.86
N	7	K-series	466	0.16	0.16	0.71
Total:			100.00	100.00	100.00	



AFM analysis



$$R_a = 1.1802 \text{ nm}$$

$$R_{ms} (R_q) = 1.5041 \text{ nm}$$

➤ **After machining** the expected emittance contribution due to surface roughness for the copper photocathode at **SPARC_LAB** is **negligible**

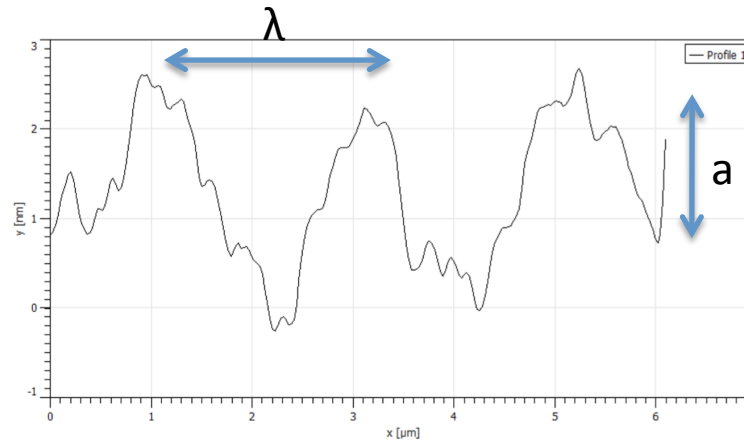
$$E_{rf} = 120 \text{ MV} / m$$

$$\vartheta_{rf} = 30^\circ$$

$$\sigma_x = 0.5 \text{ mm}$$

$$a = 1.3 \text{ nm}$$

$$\lambda = 2 \mu\text{m}$$

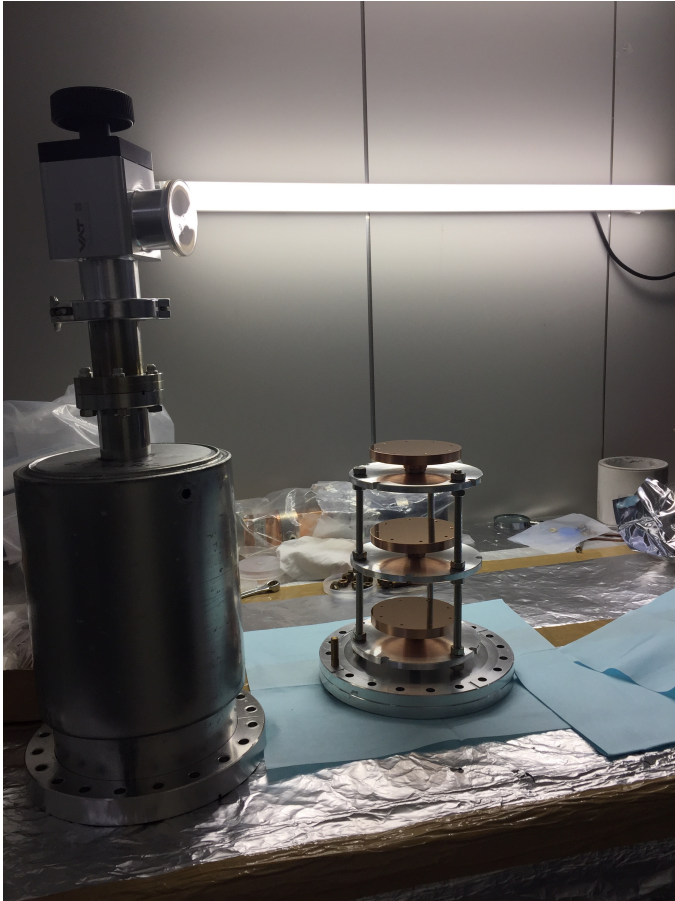


$$\varepsilon_{ns} = \sigma_x \sqrt{\frac{e\pi^2 a_n^2 E_{rf} \sin \vartheta_{rf}}{2m_0 c^2 \lambda_n}} \approx 0.011 \mu\text{m}$$

D. Xiang et al., *First principle measurements of thermal emittance for copper and magnesium*, Proc. of PAC07, Albuquerque, New Mexico, USA

- For our applications the **dry machining** is a good procedure because we don't have traces of diamond paste or oil
- We obtain an excellent roughness ($\leq 2\text{nm}$) typical of monocrystalline copper cathode
- Likely a surface roughness induced emittance will be negligible

Photocathodes chamber



It can hold three cathodes at a time.

It's a clean chamber with nitrogen over pressure.

Conclusions

- For our applications the dry machining is a good procedure because we don't have traces of diamond paste or oil.
- We obtain an excellent roughness ($\leq 2\text{nm}$) typical of monocrystalline copper cathode.
- Likely a surface roughness induced emittance will be negligible.

- ✧ **D. Alesini, S. Bellucci, A. Biagioni, E. Chiadroni, R. Di Raddo, M. Ferrario, F. Micciulla (INFN-LNF)**
- ✧ **A. Cianchi (INFN-Roma Tor Vergata and Università di Roma "Tor Vergata")**
- ✧ **A. Lorusso (Università del Salento, Dipartimento di Matematica e Fisica "E. De Giorgi", INFN-Sezione di Lecce)**
- ✧ **Daniele Passeri (SBAI- Università di Roma "La Sapienza")**

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Finally it's over

Thank you for your attention